

ANTREX Electronics

Electronic Components Sourcing Information

Product Reference Information

Part Number: B88069X8481T123
Manufacturer: TDK
Package: Tape & Reel (TR)
Availability: Please confirm with sales

Product Page:

<https://antrexco.com/product/details/tdk/b88069x8481t123.html>

Request a Quote:

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Quality & Trust

New & Original Components

Supplier verification and packaging condition review

CoC / RoHS / REACH documents available on request

Secure sourcing support for OEM / EMS projects

Note:

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.



Surge arrester

3-electrode arrester

Series/Type:	EZ0-A470XSMD
Ordering code:	B88069X8481T123
Date:	2026-04-01
Version:	07

Surge arrester

B88069X8481T123

3-electrode arrester

EZ0-A470XSMD

Features

- Small size
- Fast response time
- High current rating
- Stable performance over life
- Very low capacitance
- High insulation resistance
- Excellent SMD handling
- RoHS-compatible

Applications

- Modem
- Data lines

Electrical specifications

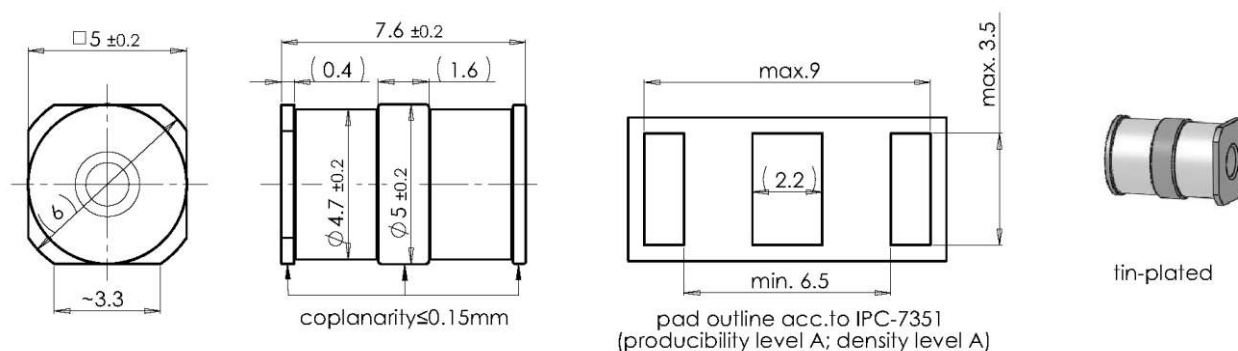
DC spark-over voltage ^{1) 2) 3)}	470	V
Tolerance	±20	%
Min.	376	V
Max.	564	V
Impulse spark-over voltage ³⁾		
at 100 V/μs - for 99% of measured values	< 850	V
- typical values of distribution	< 750	V
at 1 kV/μs - for 99% of measured values	< 1050	V
- typical values of distribution	< 850	V
Service life		
10 operations 50 Hz; 1 s ⁴⁾	5	A
10 operations [5x (+) & 5x (-)] 8/20 μs ⁴⁾	5	kA
Insulation resistance at 100 V _{DC} ³⁾	> 1	GΩ
Capacitance at 1 MHz ³⁾	< 1.5	pF
Transverse delay time ⁵⁾	< 0.2	μs
Arc voltage at 1 A	~ 6	V
Glow to arc transition current	< 0.1	A
Glow voltage at 0.1 A	~ 50	V
Weight	~ 1	g
Operation and storage temperature	-40 ... +125	°C
Climatic category (IEC 60068-1)	40/125/21	
Marking, blue negative	TDK EZ 470 YY EZ - Series 470 - Nominal voltage YY - Year of production	
Certifications	UL 497B (E163070)	

Remarks on next page

- 1) At delivery AQL 0.65 level II, DIN ISO 2859
- 2) In ionized mode
- 3) Tip or ring electrode to center electrode
- 4) Total current through center electrode, half value through tip respectively ring electrode.
- 5) Test according to ITU-T Rec. K.12

Terms in accordance with ITU-T Rec. K.12 and IEC 61643-311.

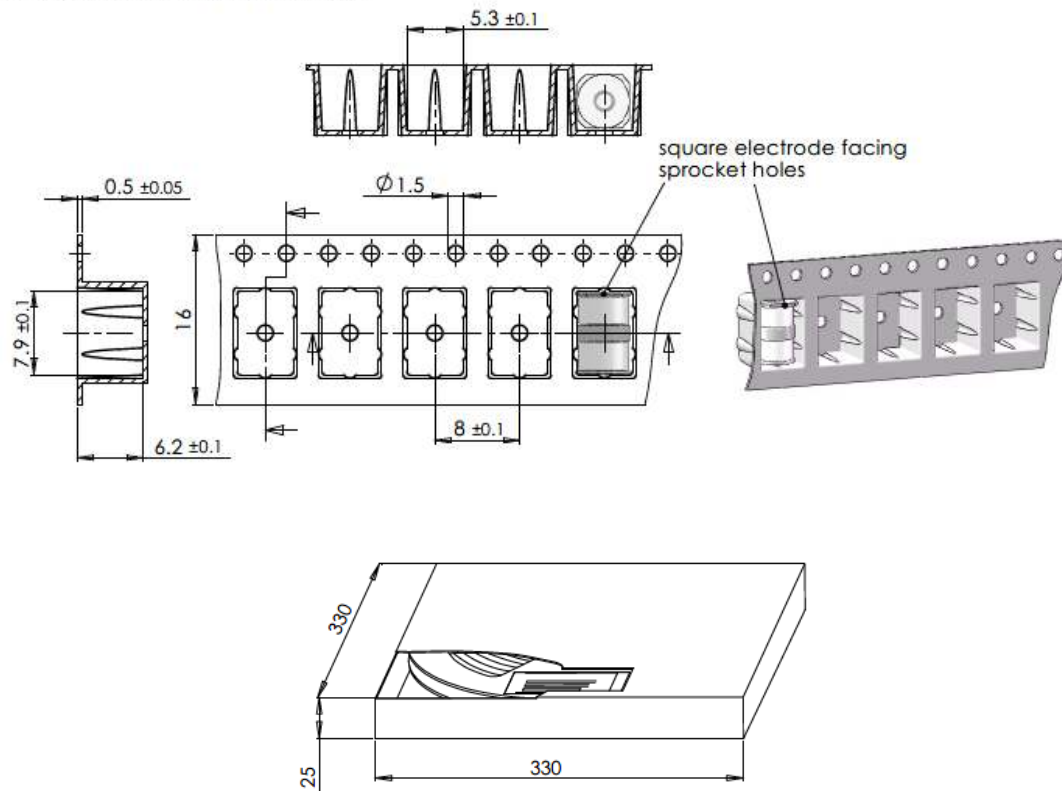
Dimensional drawing in mm



Ordering code and packing advice

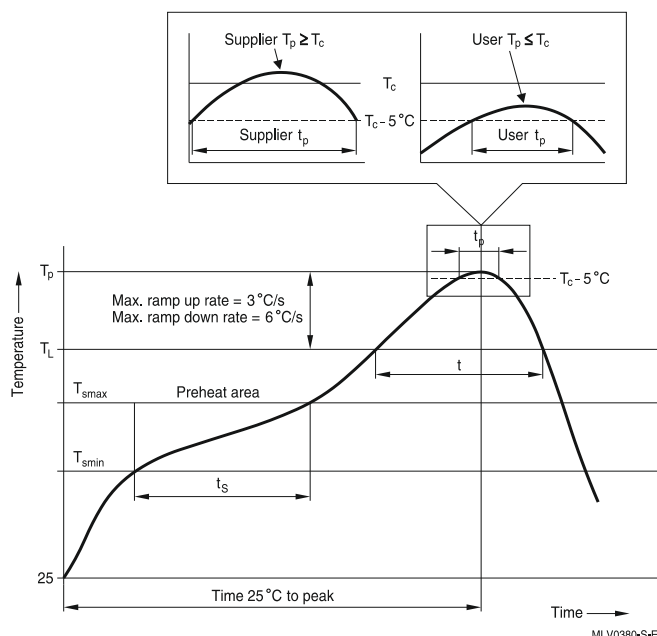
B88069X8481T123 = SMD-tape with 1200 pcs.

SMD-tape according to IEC 60286-3



Soldering parameter

Reflow soldering



Reflow profile features		Sn- Pb eutectic assembly	Pb-free assembly
Preheat and soak - Temperature min - Temperature max - Time	T_{smin} T_{smax} t_{smin} to t_{smax}	100 °C 150 °C 60 ... 120 s	150 °C 200 °C 60 ... 180 s
Average ramp-up rate	T_{smax} to T_p	max. 3 °C/ s	max. 3 °C/ s
Liquidous temperature	T_L	183 °C	217 °C
Time at liquidous	t_L	60 ... 150 s	60 ... 150 s
Peak package body temperature *, Classification temperature **	T_p, T_c	220 ... 235 °C **	245 ... 260 °C **
Time (t_p) ** within 5 °C of the specified classification temperature (T_c)		20 s ***	30 s ***
Average ramp-down rate	T_p to T_{smax}	max. 6 °C/ s	max. 6 °C/ s
Time 25 °C to peak temperature		max. 6 min	max. 8 min
* = Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum. ** = For details please refer to JEDEC J-STD-020D. *** = Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.			

Surface mounted components (SMD) may exhibit a temporary increase in the DC spark-over voltage after the solder reflow process. The components will recover within 24 hours. There is no quality defect nor change in protection levels during the temporary change in DC spark-over voltage.

Cautions and warnings

- Do not operate surge arresters in power supply networks, whose maximum operating voltage exceeds the minimum spark-over voltage of the surge arresters.
- Surge arresters may become hot in the event of longer periods of current stress (burn risk). In the event of overload the connectors may fail or the component may be destroyed.
- Surge arresters must be handled with care and must not be dropped.
- Do not continue to use damaged surge arresters.
- The shown SMD pad dimensions represent a safe way to mount the arrester and are a recommendation of the manufacturer. During the reflow process it must be assured that no solder material reduces the insulation distance between the pads below the arrester.
- SMD surge arresters should be soldered within 24 month after shipment.

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Important notes

8. The trade names EPCOS, CarXield, CeraCharge, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CTVS, DeltaCap, DigiSiMic, FilterCap, FormFit, InsuGate, LeaXield, MediPlas, MiniBlue, MiniCell, MKD, MKK, ModCap, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PiezoBrush, PlasmaBrush, PowerHap, PQSine, PQvar, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, SurfIND, ThermoFuse, WindCap, XieldCap are **trademarks registered or pending** in Europe and in other countries. Further information will be found on the Internet at www.tdk-electronics.tdk.com/trademarks.

Release 2024-02